

IN THE CLAIMS

Please amend claim 1-4.

Please rewrite claim 1-4 as follows :

(Amended 1. A small memory card to be set in an electric device,
5 comprising :

A substrate having an upper surface and a lower surface, the upper surface
formed with a plurality of connected points and a plurality of golden fingers to
electrically connect to the plurality of connected points, the substrate is used to set
in the electric device, so that, the golden finger may be electrically connected to
10 the electric device;

At least a memory chip arranged on the upper surface of the substrate and
electrically connected to the connected points of the substrate; and

A transparent layer encapsulated on memory chip to protect the memory
chip and display the mark of the memory chip.

15 (Amended)2.The transparent small memory card according to claim 1,
wherein the memory chip is located on the lower surface of the substrate, and the
transparent layer is encapsulated the memory chip.

(Amended)3. The small memory card according to claim 1, wherein the
upper surface of the substrate is arranged with two memory chips, and transparent
20 layer is encapsulated the two memory chips.

(Amended)4. The small memory card according to claim 1, wherein the memory chip is electrically connected to the connected points of the substrate.

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